



N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

BVDSS	Rds(on)	I _D T _A = +25°C
201/	460mΩ @ V _{GS} = 4.5V	1.3A
30V	560mΩ @ V _{GS} = 2.5V	1.25A

Description and Applications

This new generation MOSFET is designed to minimize the on-state resistance (RDS(ON)) yet maintain superior switching performance, making it ideal for high-efficiency power-management applications.

- Power-management functions
- Backlighting
- Load switches

Features and Benefits

- Low On-Resistance
- Low Input/Output Leakage
- Fast Switching Speed
- ESD Protected Gate
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/104/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative.

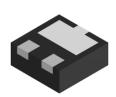
https://www.diodes.com/quality/product-definitions/

Mechanical Data

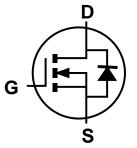
- Package: X2-DFN1010-3
- Package Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Terminals: Finish NiPdAu over Copper Leadframe;
 Solderable per MIL-STD-202, Method 208
- Weight: 0.0015 grams (Approximate)



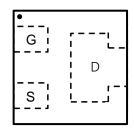




Bottom View



Equivalent Circuit



Pin-Out Top View

Ordering Information (Note 4)

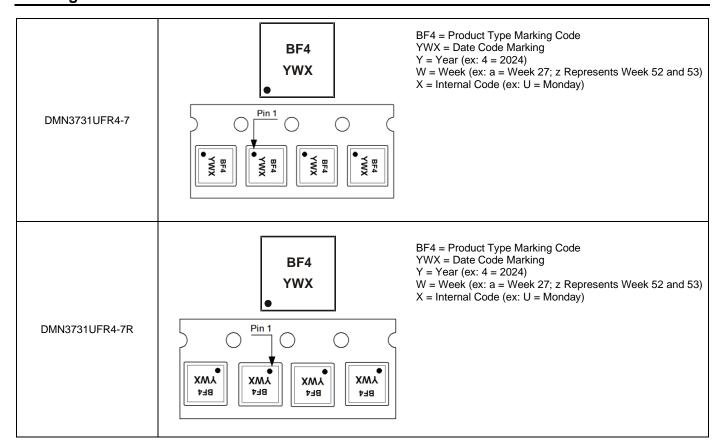
Orderable Part Number	Pookogo	Tana Width (mm)	Tono Bitch (mm)	Packing		
Orderable Part Number	Package	Tape Width (mm)	Tape Pitch (mm)	Qty.	Carrier	
DMN3731UFR4-7	X2-DFN1010-3	8	4	5000	Tape & Reel	
DMN3731UFR4-7R	X2-DFN1010-3	8	4	5000	Tape & Reel	

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.



Marking Information



Date Code Key

Year	2021	-	2024	2025	2026	2027	2028	2029	2030	2031	2032	2033
Code	1	-	4	5	6	7	8	9	0	1	2	3

Week	1-26	27-52	53
Code	A-Z	a-z	z

	Internal Code	Sun	Mon	Tue	Wed	Thu	Fri	Sat
ſ	Code	Т	U	V	W	X	Υ	Z



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage	V_{DSS}	30	V		
Gate-Source Voltage	Vgss	±8	V		
Continuous Drain Current (Note 6) V _{GS} = 4.5V	Steady State	T _A = +25°C T _A = +100°C	ΙD	1.3 0.84	А
Maximum Continuous Body Diode Forward Current	Is	1.4	Α		
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)	IDM	3.3	Α		

Thermal Characteristics

Characteristic	Symbol	Value	Unit	
Total Power Dissipation (Note 5)		PD	0.67	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	RθJA	187	°C/W
Total Power Dissipation (Note 6)		P _D	1.32	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	RθJA	95	°C/W
Operating and Storage Temperature Range		TJ, TSTG	-55 to +150	°C

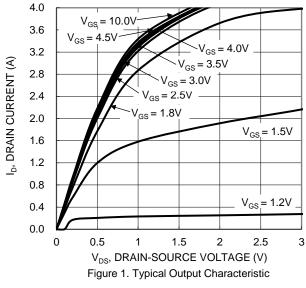
Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)						
Drain-Source Breakdown Voltage	BVDSS	30		_	V	$V_{GS} = 0V, I_{D} = 10\mu A$
Zoro Coto Voltago Drain Current	1	_	_	1	μΑ	$V_{DS} = 30V, V_{GS} = 0V$
Zero Gate Voltage Drain Current	I _{DSS}	_	_	100	nA	V _{DS} = 12V, V _{GS} = 0V
Gate-Source Leakage	Igss	_	_	3	μΑ	$V_{GS} = \pm 8V$, $V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	Vgs(TH)	0.45	_	0.95	V	$V_{DS} = V_{GS}$, $I_D = 250\mu A$
			210	460		$V_{GS} = 4.5V, I_D = 200mA$
Static Drain-Source On-Resistance	RDS(ON)	_	225	560	mΩ	$V_{GS} = 2.5V, I_{D} = 100mA$
			250	730		$V_{GS} = 1.8V, I_{D} = 75mA$
Diode Forward Voltage	V_{SD}	_	0.7	1.2	V	$V_{GS} = 0V, I_{S} = 300mA$
DYNAMIC CHARACTERISTICS (Note 8)						
Input Capacitance	Ciss		73	_		V 05V V 0V
Output Capacitance	Coss		7.2		pF	$V_{DS} = 25V, V_{GS} = 0V,$
Reverse Transfer Capacitance	Crss	_	5	_		f = 1.0MHz
Gate Resistance	R_g		902	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$
Total Gate Charge	Q_g	_	5.5			V 45V V 45V
Gate-Source Charge	Qgs	_	0.8	_	nC	Vgs = 4.5V, VDs = 15V,
Gate-Drain Charge	Q_{gd}	_	1.4			I _D = 1A
Turn-On Delay Time	td(ON)	_	2.5	_		
Turn-On Rise Time	t _R	_	3.1	_	1	$V_{DS} = 10V, I_{D} = 1A$
Turn-Off Delay Time	tD(OFF)		477	_	ns	$V_{GS} = 10V, R_{G} = 6\Omega$
Turn-Off Fall Time	t _F	_	123	_		
Reverse Recovery Time	t _{RR}	_	59	_	ns	I_ 10 di/dt 1000/up
Reverse Recovery Charge	Q _{RR}	_	25	_	nC	I _F = 1A, di/dt = 100A/μs

 Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
 Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.
 Short duration pulse test used to minimize self-heating effect. Notes:

^{8.} Guaranteed by design. Not subject to production testing.





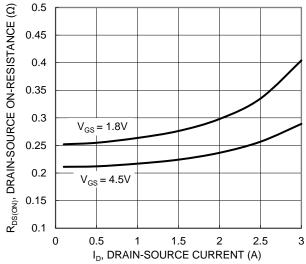


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

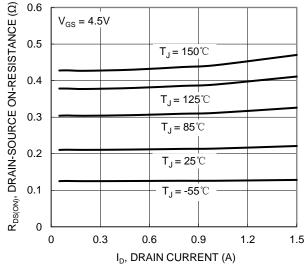
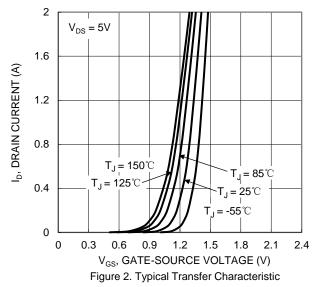
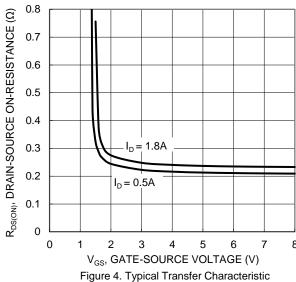


Figure 5. Typical On-Resistance vs. Drain Current and Junction Temperature





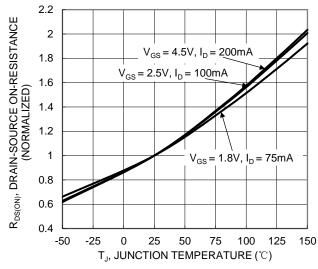


Figure 6. On-Resistance Variation with Junction Temperature



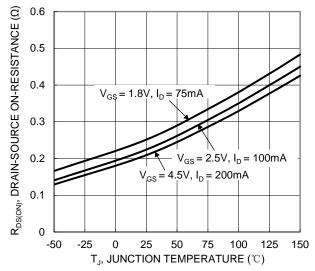
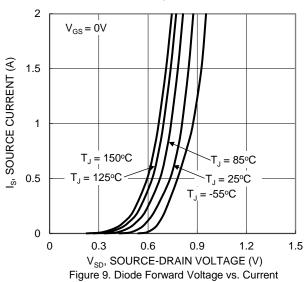
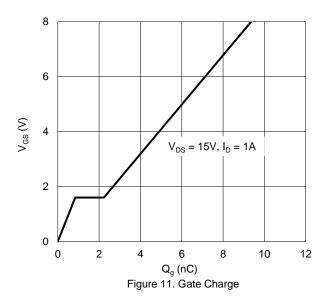


Figure 7. On-Resistance Variation with Junction Temperature





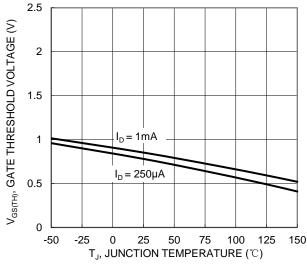
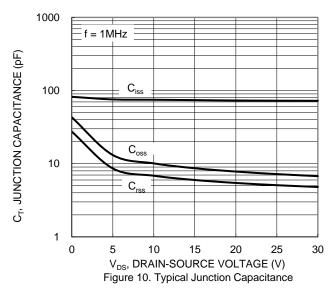
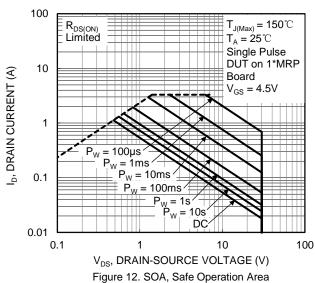


Figure 8. Gate Threshold Variation vs. Junction Temperature







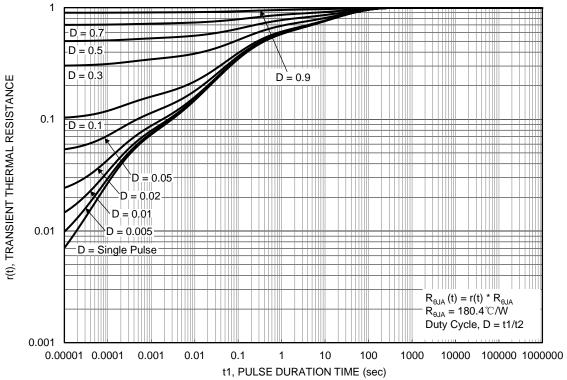


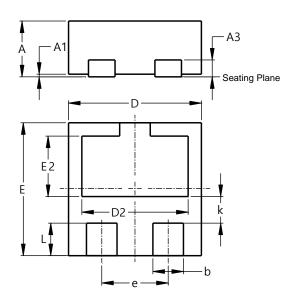
Figure 13. Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

X2-DFN1010-3

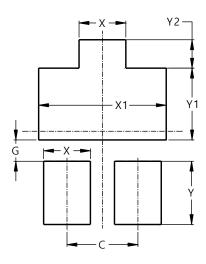


	X2-DF	N1010-3	3
Dim	Min	Max	Тур
Α	-	0.40	0.39
A 1	0.00	0.05	0.02
А3	-	-	0.13
b	0.18	0.28	0.23
D	0.95	1.05	1.00
D2	0.70	0.90	0.80
Е	0.95	1.05	1.00
E2	0.36	0.56	0.46
е	-	-	0.50
k	-	-	0.20
L	0.195	0.295	0.245
Α	II Dimen	sions in	mm

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

X2-DFN1010-3



Dimensions	Value
Dilliensions	(in mm)
С	0.500
G	0.150
Х	0.330
X1	0.900
Υ	0.445
Y1	0.505
Y2	0.200



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